



#### **60V N-CHANNEL ENHANCEMENT MODE MOSFET**

#### **Product Summary**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)</sub> max	I <sub>D</sub> max T <sub>A</sub> = +25°C
60V	18mΩ @ V <sub>GS</sub> = 10V	9.2 A
	$28m\Omega @ V_{GS} = 4.5V$	7.5 A

### **Description and Applications**

This MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and maintain superior switching performance, making it ideal for high efficiency power management applications.

- Load Switch
- Adaptor Switch
- Notebook PC

#### **Features and Benefits**

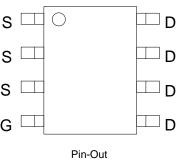
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Mechanical Data**

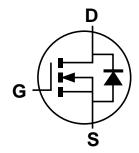
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See diagram
- Terminals: Finish Matte Tin annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (23)
- Weight: 0.076 grams (approximate)







Pin-Out Top View



**Equivalent Circuit** 

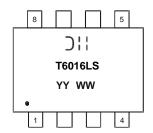
# **Ordering Information** (Note 4)

Part Number	Case	Packaging	
DMT6016LSS-13	SO-8	2500/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

### **Marking Information**



⊃¦¦ = Manufacturer's Marking
 T6016LS = Product Type Marking Code
 YYWW = Date Code Marking
 YY or YY = Year (ex: 14 = 2014)
 WW = Week (01 - 53)



# 

Characteristic			Symbol	Value	Units
Drain-Source Voltage			$V_{DSS}$	60	V
Gate-Source Voltage			$V_{GSS}$	±20	V
Continuous Drain Current (Note 6) 1/ 101/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	9.2 7.4	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 10V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	11.9 9.5	Α
Continuous Drain Current (Note 6) 1/ 4 51/	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I <sub>D</sub>	7.5 6.0	А
Continuous Drain Current (Note 6) V <sub>GS</sub> = 4.5V	t<10s	$T_A = +25$ °C $T_A = +70$ °C	Ι <sub>D</sub>	9.7 7.7	А
Pulsed Drain Current (10µs pulse, duty cycle = 1%)	$I_{DM}$	60	Α		
Maximum Continuous Body Diode Forward Current (Note 6)			Is	2	Α
Avalanche Current (Note 7) L = 0.1mH			I <sub>AS</sub>	15.3	Α
Avalanche Energy (Note 7) L = 0.1mH			E <sub>AS</sub>	11.7	mJ

### Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units	
Total Power Dissipation (Note 5)	$P_D$	1.5	W	
Thermal Resistance, Junction to Ambient (Note 5)			85	°C/W
Thermal Resistance, Junction to Ambient (Note 5)	t<10s	$R_{\theta JA}$	45	°C/W
Total Power Dissipation (Note 6)	$P_D$	2.1	W	
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	7	74	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	t<10s	$R_{\theta JA}$	37	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	13	°C/W	
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-55 to 150	°C	

# **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	_	_	1	μA	$V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	I <sub>GSS</sub>	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	$V_{GS(th)}$	1	_	2.5	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	_	18	mΩ	$V_{GS} = 10V, I_D = 10A$	
Static Dialif-Source Off-Resistance	R <sub>DS</sub> (ON)	_	_	28		VGS = 4.5V, ID = 6A	
Diode Forward Voltage (Note 7)	$V_{SD}$	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1A$	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	C <sub>iss</sub>	_	864	_		N	
Output Capacitance	Coss	_	282	_	pF	$V_{DS} = 30V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Reverse Transfer Capacitance	$C_{rss}$	_	27	_		I = I IVII IZ	
Gate resistance	Rg	_	1.3	_	Ω	$V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	8.4	_			
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	17	_	001/1 404		
Gate-Source Charge	Qgs	_	3.1	_	$V_{DS} = 30V, I_{D} = 10A$		
Gate-Drain Charge	$Q_{gd}$	_	4.3	_			
Turn-On Delay Time	t <sub>D(on)</sub>	_	3.4	_			
Turn-On Rise Time	t <sub>r</sub>	_	5.2	_		$V_{GS} = 10V, V_{DS} = 30V,$	
Turn-Off Delay Time	t <sub>D(off)</sub>	_	13	_	ns	$R_G = 6\Omega$ , $I_D = 10A$	
Turn-Off Fall Time	t <sub>f</sub>	_	7	_			
Reverse Recovery Time	T <sub>rr</sub>	_	22	_	ns	100 11/11 1000/	
Reverse Recovery Charge	Qrr	_	11	_	$I_F = 10A$ , di/dt = 100A/ $\mu$ s		

Notes:

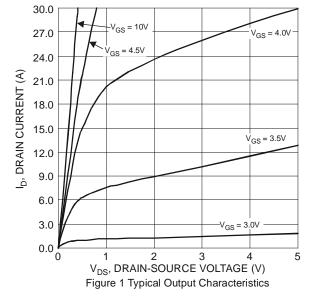
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.

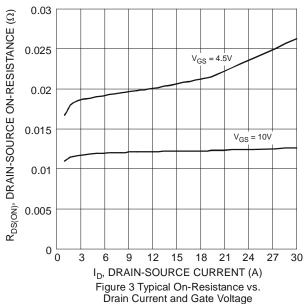
<sup>7.</sup>  $I_{AS}$  and  $E_{AS}$  rating are based on low frequency and duty cycles to keep  $T_J = +25$ °C.

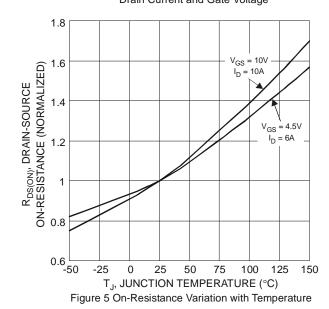
<sup>8.</sup> Short duration pulse test used to minimize self-heating effect.

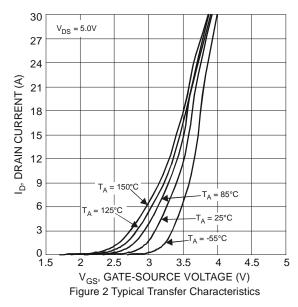
<sup>9.</sup> Guaranteed by design. Not subject to product testing.

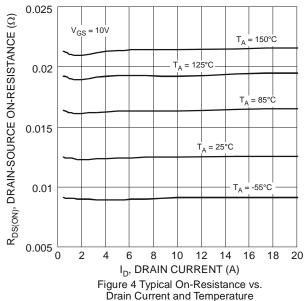












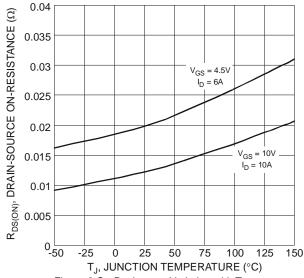


Figure 6 On-Resistance Variation with Temperature



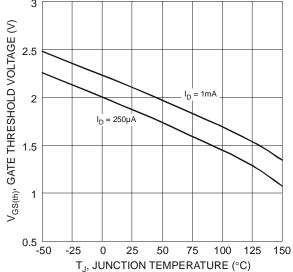


Figure 7 Gate Threshold Variation vs. Ambient Temperature

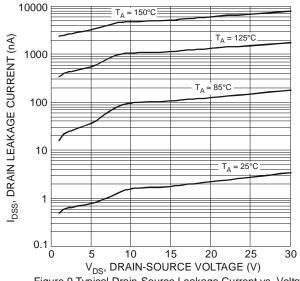
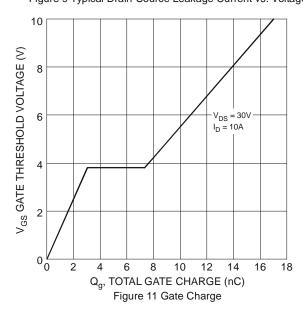
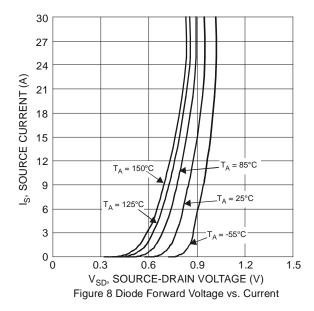
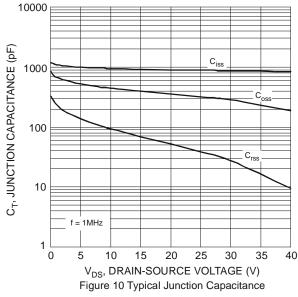
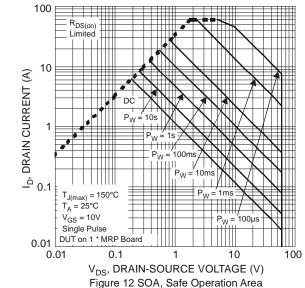


Figure 9 Typical Drain-Source Leakage Current vs. Voltage

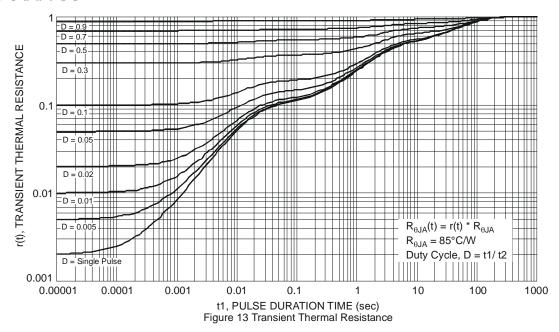






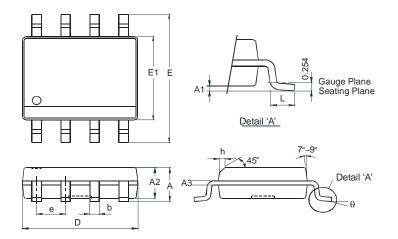






## **Package Outline Dimensions**

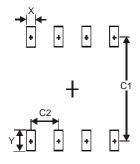
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SO-8					
Dim	Min	Max			
Α	-	1.75			
A1	0.10	0.20			
A2	1.30	1.50			
A3	0.15	0.25			
b	0.3	0.5			
D	4.85	4.95			
Е	5.90	6.10			
E1	3.85	3.95			
е	1.27 Typ				
h	-	0.35			
٦	0.62	0.82			
θ	0°	8°			
All Dimensions in mm					

# **Suggested Pad Layout**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



Dimensions	Value (in mm)		
X	0.60		
Υ	1.55		
C1	5.4		
C2	1.27		



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